ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Compo © Copyright 2005. IPG international and Pan-	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
Supplier Inform	nation														
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*			
nsemi										2024-04-24					
Contact Name		Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-Env-Stew	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repres	entative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stew	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Request	quester Item Number Mfr Item		m Number Mfr Item Name				Effective Date	e Version Manufacturing Site		7	Veight*	UOM	Unit Type		
		MAX803SQ293D3T1 ANA 2.93V MCROPF		ROPROC RES	ET	2024-04-24			MY1		i.0	mg	Each		
Ianufacturing	Proccess Informati	ion													
Terminal Plating / Grid Array Material Terminal Ba			erminal Base A	Alloy	SL Rating	Peak Process Body Temperature Max Time at Peal			k Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed		C	CU Alloy 1		1		260		С	30	secono	ds 3			
omments															
vel 1 - maximum	time at peak temperatur	e during sol	dering is 10-3	0 seconds											
or more informat	ion regarding material c	omposition	please refer to	page 3					· · · · · · · · · · · · · · · · · · ·						

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg
Die Attach	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.1125	mg
			Supplier	Epoxy resins	129915-35-1		0.0375	mg
Lead Frame	1.93	mg	В	Nickel (Ni)	7440-02-0		0.7392	mg
			Supplier	Iron (Fe)	7439-89-6		1.021	mg
			Supplier	Copper (Cu)	7440-50-8		0.1698	mg
Mold Compound-Black	3.7	mg		Epoxy resin	proprietary data		0.185	mg
			Supplier	Phenolic Resin	Proprietary Data		0.185	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.074	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0185	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.2375	mg
Plating	0.11	mg	Supplier	Tin (Sn)	7440-31-5		0.11	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg